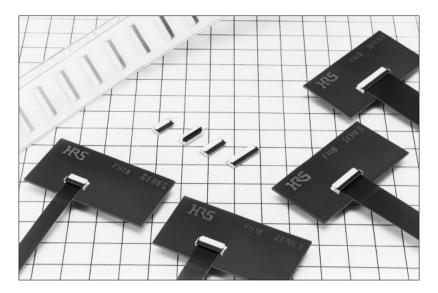
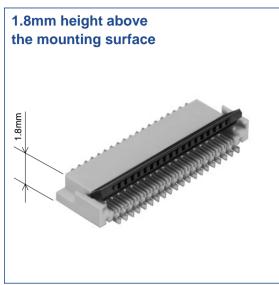
Low Profile 0.3mm Pitch Connectors For FPC

FH18 Series





Features

1. Low profile 0.3mm pitch FPC connectors

In response to continuous miniturization of products, the demand for smaller contact spacing on connectors is increasing. Flexible printed circuits(FPC) with contact pitch of 0.3mm are used with increased frequency. FH18 series connectors fullfill this requirement. In addition, these connectors occupy less board space and are lighter than comparable connectors with contacts spaced at 0.5mm.

2. Improved Retention of FPC

Two types of contacts design are combined in the FH18 connector, zero insertion force(ZIF) and low insertion force(LIF). Inserted FPC is held in place by the LIF contact, allowing operator to close down the actuator and engage the ZIF contacts to assure complete connection.

3. Easy to use Flip-Lock Actuator

Flip-lock (rotating type) ZIF mechanism enables good connectivity of FPC by a simple operation and light force. No board space is required for flip lock operation as compared to slide lock ZIF connectors.

4. Placement on Board

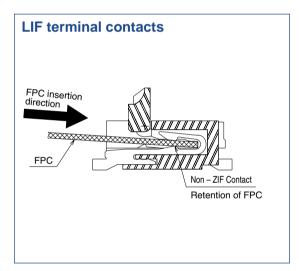
The leads are on two sides of the connector, spaced on 0.6mm and are visible for solder joint inspection. Flat top surface of the connector allows board placement with automated equipment.

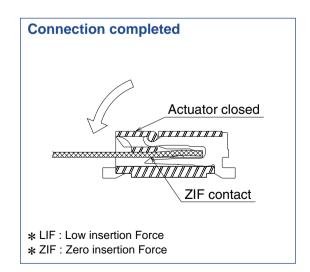
5. Variety of Contact Positions

The connectors are available with 17,21,25,27,39,45 and 51 contacts.

■Applications

Notebook computers, printers, PDAs, digital cameras and other compact devices for interconnecting the main circuit board with the LCD, PDP (Plasma Display), HDD or other device.





■Product Specifications

Rating	Current rating 0.15A Voltage rating 30V AC	Operating temperature range Operating humidity range	-40°C to +85°C (Note 1) Relative humidity 90% max. (without condensation)	Storage temperature range Storage humidity range	-10°C to +50°C (Note 2) Relative humidity 90% max. (without condensation)
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Applicable FPC	t=0.2±0.03	Tin-lead plated (Note 3)
Applicable I I C	1-0.2-0.03	Titi-lead plated (Note 3)

Item	Specification	Conditions
1.Insulation resistance	50M ohms minimum	100V DC
2.Withstanding voltage	No flashover or insulation breakdown.	90V AC/1 minute
3.Contact resistance	100m ohms maximum	1mA
4.Durability (Insertion/withdrawal)	Contact resistance : 100m ohms maximum No damage, cracks, or parts dislocation.	10 cycles
5.Vibration	No electrical discontinuity of 1 μ s or more Contact resistance: 100m ohms maximum No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours in each of the 3 directions.
6.Shock	No electrical discontinuity of 1 μ s or more Contact resistance: 100m ohms maximum No damage, cracks, or parts dislocation.	Acceleration of 490 m/s², 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
7.Humidity (Steady state)	Contact resistance: 100m ohms maximum Insulation resistance: 50M ohms minimum No damage, cracks, or parts dislocation.	96 hours at temperature of 40°C and humidity of 90% to 95%
8.Temperature cycle	Contact resistance: 100m ohms maximum. Insulation resistance: 50M ohms minimum. No damage, cracks, or parts dislocation.	5 cycles under conditions as follows; Temperature: $-40^{\circ}C \rightarrow 15 \text{ to } 35^{\circ}C \rightarrow 85^{\circ}C \rightarrow 15 \text{ to } 35^{\circ}C$, Time: $30 \rightarrow 5 \text{max}. \rightarrow 30 \rightarrow 5 \text{ max.}(\text{minutes})$
9.Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350±5°C for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers nonconducting condition of installed connectors in storage, shipment or during transportation.

Note 3: When FPC is gold plated, the connector contacts should be also gold plated: Select the (55) specification.

■Material

Part	Material	Finish	Remarks	
Insulator	LCP	Color : Beige	UL 94V-0	
moulator	LOI	Color : Black		
Contact	Phosphor bronze	Tin-lead plated		
Metal fitting	Bronze	Tin-lead plated		

■Ordering Information

FH18	- 27S -	0.3	SHW	(55)
0	2	3	4	6

1	Series name	FH18		
2	Number of contacts	17, 21, 25, 27, 39, 45, 51		
3	Contact pitch	0.3mm		
4	Contact style	SHW: SMT horizontal mounting type		
6	Plating specifications Blank : Tin-lead plated			
	(55): Gold plated			

◆Connector Operating Instructions, precautions and recommendations

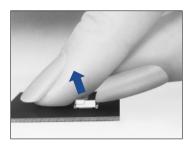
1.FPC Termination procedure. Connector installed on the board.

1) Lift up the actuator. Use thumb or index finger.

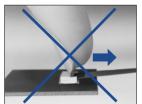
Operation

1) Do not apply excessive force or use any type of tool to operate the actuator.

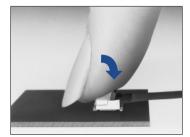
Precautions







2) Rotate down the actuator until firmly closed. It is critical that the inserted FPC is not moved and remains fully inserted. Should the FPC be moved, open the actuator and repeat the process, starting with Step 1 above.



2) The connector will assure reliable performance when the actuator is open to 130° maximum (see fig.1) Do not exceed this angle, as this may cause permanent damage to the connector.

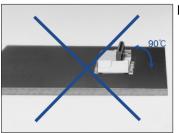
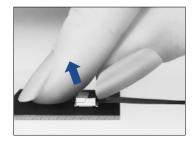


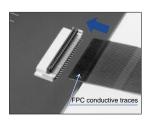
Fig.1

2.FPC Removal

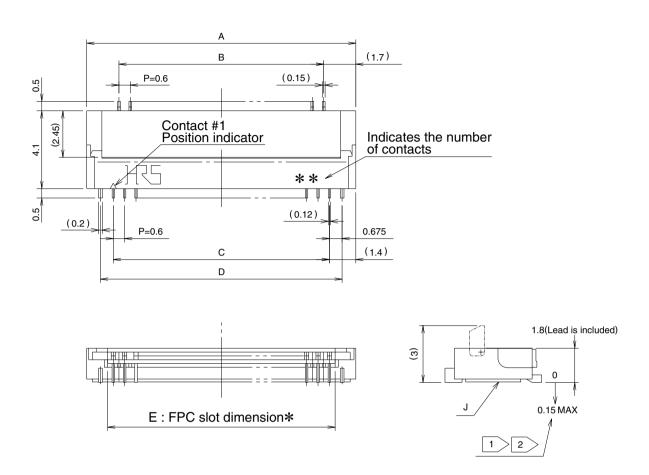
- 1) Lift up the actuator.
- 2) Carefully remove the FPC.



3) Assure that the FPC/FFC is fully inserted parallel to mounting surface, with the exposed conductive traces facing down.







Notes 1 Indicates the distance from J surface.

2 The coplanarity of each lead and metal fitting within 0.1.(coplanarity: The distance between the lowest and highest land)

3 This connector uses LIF(Low Insertion Force) and ZIF(Zero Insertion Force) contact design. Slight friction will be felt during insertion of FPC in the slot. Full insertion of FPC is required for secure connection.

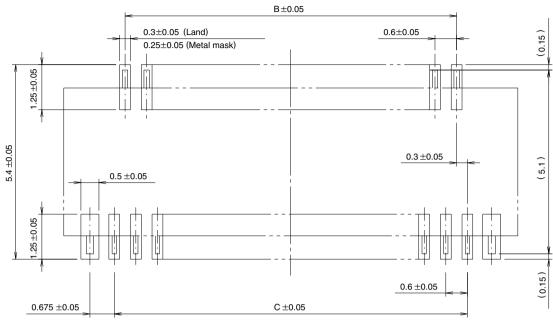
Unit: mm

Part Number	CL No.	Number of contacts	Α	В	С	D	Е
FH18-17S-0.3SHW	586-0684-5	17	7.6	4.2	4.8	6.15	5.4
FH18-21S-0.3SHW	586-0669-1	21	8.8	5.4	6.0	7.35	6.6
FH18-25S-0.3SHW	586-0685-8	25	10.0	6.6	7.2	8.55	7.8
FH18-27S-0.3SHW	586-0658-5	27	10.6	7.2	7.8	9.15	8.4
FH18-39S-0.3SHW	586-0646-6	39	14.2	10.8	11.4	12.75	12.0
FH18-45S-0.3SHW	586-0694-9	45	16.0	12.6	13.2	14.55	13.8
FH18-51S-0.3SHW	586-0671-3	51	17.8	14.4	15.0	16.35	15.6

Note: Embossed tape reel packaging (2,500 pieces/reel).

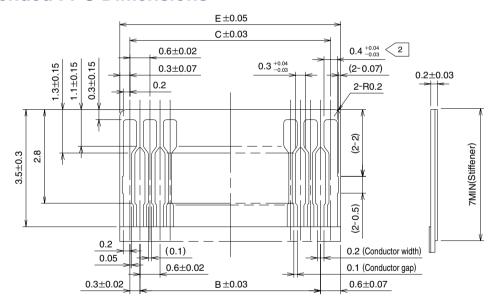
Order by number of reels.

♠ Recommended Land/ Metal Mask Dimensions



*Recommended metal mask thickness: t=0.15

♠Recommended FPC Dimensions



Note 1 Polyimide and thermal hardening glue are a recommendation for the stiffener.

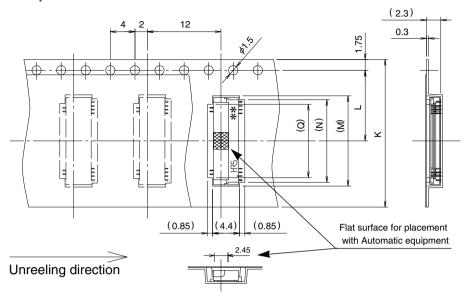
 $\boxed{2}$ When drawing a plated lead, $0.3^{+0.04}_{-0.03}$ is also permitted.

Unit: mm

					Orne. min
Part Number	CL No.	Number of contacts	В	С	Е
FH18-17S-0.3SHW	586-0684-5	17	4.2	4.8	5.4
FH18-21S-0.3SHW	586-0669-1	21	5.4	6.0	6.6
FH18-25S-0.3SHW	586-0685-8	25	6.6	7.2	7.8
FH18-27S-0.3SHW	586-0658-5	27	7.2	7.8	8.4
FH18-39S-0.3SHW	586-0646-6	39	10.8	11.4	12.0
FH18-45S-0.3SHW	586-0694-9	45	12.6	13.2	13.8
FH18-51S-0.3SHW	586-0671-3	51	14.4	15.0	15.6

● Packaging Specifications

•Embossed Carrier Tape Dimensions

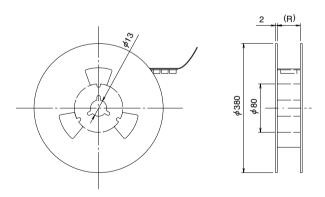


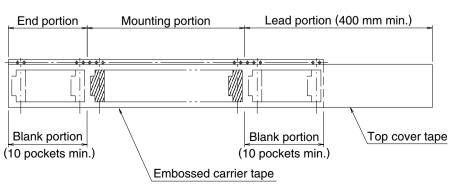
Unit: mm

Part Number	CL No.	Number of contacts	K	L	М	N	Q	R
FH18-17S-0.3SHW	586-0684-5	17	16	7.5	7.9	6.6	5.1	16.5
FH18-21S-0.3SHW	586-0669-1	21	16	7.5	9.1	7.8	6.3	16.5
FH18-25S-0.3SHW	586-0685-8	25	24	11.5	10.3	9.0	7.5	24.5
FH18-27S-0.3SHW	586-0658-5	27	24	11.5	10.9	9.6	8.1	24.5
FH18-39S-0.3SHW	586-0646-6	39	24	11.5	14.5	13.2	11.7	24.5
FH18-45S-0.3SHW	586-0694-9	45	24	11.5	16.3	15.0	13.5	24.5
FH18-51S-0.3SHW	586-0671-3	51	24	11.5	18.1	16.8	15.3	24.5

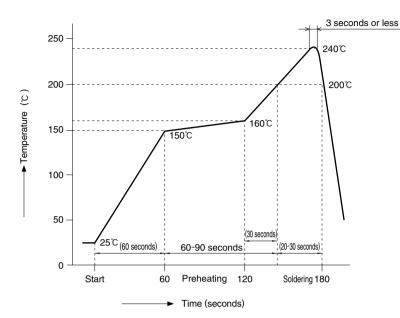
Note:2,500 pieces per reel.

Reel Dimensions





●Recommended Temperature Profile



HRS test conditions

Solder method :Reflow, IR/hot air (Nihon Den-netsu Co., Ltd.'s Part Number: SENSBY NR- II)

Environment :Room air

Solder composition :Paste, 63%Sn/37%Pb

(Senju Metal Industry, Co., Ltd.'s Part

Number: OZ63-201C-50-9)

Test board :Glass epoxy 70mm×70mm×1.6mm thick

Land dimensions :0.3mm×1.25mm

Metal mask :0.25mm×1.25mm×0.15mm thick

This temperature profile is based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

● FH18 Series Construction (Recommended Specifications)

1. Single-Sided FPC Material Name Material Thickness (µm) Covering layer film Polyamide 1 mil 25 ** Cover adhesive 25 Surface treatment 5 Tin-lead plating Copper foil Cu 35 Base adhesive 25 Base film Polyamide 1 mil 25 Reinforcement material adhesive 30 Stiffener Polyamide 3 mil 75 Total 195

2. Using Double-Sided FPC Material Name Material Thickness (µm) Polyamide 1 mil Covering layer film 25 Cover adhesive 25 Surface treatment Tin-lead plating 5 Through hole copper Cu 15 Copper foil Cu 1/2oz 18 Base adhesive 18 Base film Polyamide 1 mil 25 Base adhesive 18 Copper foil Cu 1/2oz 18 Cover adhesive 25 Polyamide 1 mil Cover layer film 25 25 Reinforcement material adhesive Stiffener Polyamide 1 mil 25 Total 199

Note: Stiffener is not required for the double-sided FPC.

To prevent release of the lock due to FPC bending, please do not use copper foil on the rear side.

3. Precautions

- 1. This specification is a recommendation for the construction of the FH18 Series FPC ($t=0.2\pm0.03$).
- 2. For details about the construction, please contact the FPC/FFC manufacturers.

FPC/FFC Manufactures' Contact List

Sumitomo Bakelite Co., Ltd. Flexible Printed Circuit Board Division 5-8, Higashi-shinagawa 2-chome, Shinagawa-ku, Tokyo, Japan	TEL:+81 3 5462 4191 FAX:+81 3 5462 4882
Fujikura Ltd. Electronics Global Marketing Department 1-5-1, Kiba, Koto-ku, Tokyo, Japan	TEL:+81 3 5606 1165 FAX:+81 3 5606 1530
NOK Corporation Sales Division Overseas Business Department 1-12-15, Shiba-Daimon, Minato-ku, Tokyo, Japan	TEL:+81 3 3432 6976/8415 FAX:+81 3 3432 3919